
DISCRETE POWER DIODES and THYRISTORS

DATA BOOK



SD103N/R SERIES

FAST RECOVERY DIODES

Stud Version

Features

- High power FAST recovery diode series
- 1.0 to 2.0 μ s recovery time
- High voltage ratings up to 2500V
- High current capability
- Optimized turn on and turn off characteristics
- Low forward recovery
- Fast and soft reverse recovery
- Compression bonded encapsulation
- Stud version JEDEC DO-30
- Maximum junction temperature 125°C

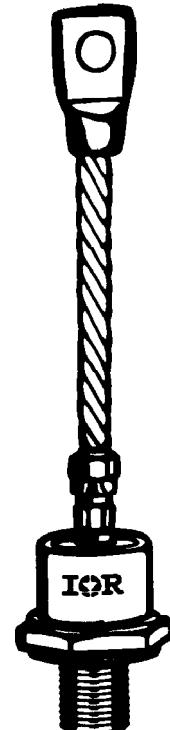
110A

Typical Applications

- Snubber diode for GTO
- High voltage free-wheeling diode
- Fast recovery rectifier applications

Major Ratings and Characteristics

Parameters	SD103N/R	Units
$I_{F(AV)}$	110	A
@ T_c	85	°C
$I_{F(RMS)}$	173	A
I_{FSM}	@ 50Hz @ 60Hz	3570 3730
I^2t	@ 50Hz @ 60Hz	KA ² s KA ² s
V_{RRM} range	400 to 2500	V
t_{rr} range	1.0 to 2.0	μ s
@ T_j	25	°C
T_j	- 40 to 125	°C



case style
DO-205AC (DO-30)

ELECTRICAL SPECIFICATIONS

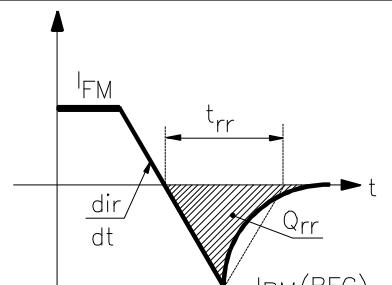
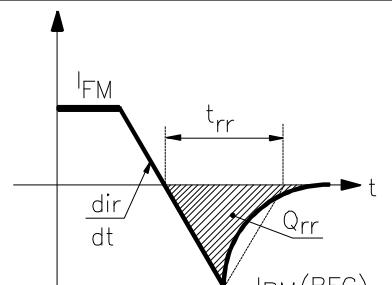
Voltage Ratings

Type number	Voltage Code	V_{RRM} max. repetitive peak and off-state voltage V	V_{RSM} , maximum non-repetitive peak voltage V	I_{RRM} max. $T_J = 125^\circ C$ mA
SD103N/R..S10	04	400	500	35
	08	800	900	
	10	1000	1100	
SD103N/R..S15	12	1200	1300	35
	14	1400	1500	
	16	1600	1700	
SD103N/R..S20	20	2000	2100	35
	25	2500	2600	

Forward Conduction

Parameter	SD103N/R	Units	Conditions
$I_{F(AV)}$ Max. average forward current @ Case temperature	110	A	180° conduction, half sine wave.
	85	°C	
$I_{F(RMS)}$ Max. RMS current	173	A	DC @ 75°C case temperature
I_{FSM} Max. peak, one-cycle non-repetitive forward current	3570	A	Sinusoidal half wave, Initial $T_J = T_J$ max.
	3730		
	3000		
	3140		
I^2t Maximum I^2t for fusing	64	KA ² s	No voltage reapplied
	58		
	45		
	41		
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	636	KA ² /s	t = 0.1 to 10ms, no voltage reapplied
$V_{F(TO)1}$ Low level of threshold voltage	1.36	V	(16.7% $\times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)}$), $T_J = T_J$ max.
$V_{F(TO)2}$ High level of threshold voltage	1.94		(I > $\pi \times I_{F(AV)}$), $T_J = T_J$ max.
r_{f1} Low level of forward slope resistance	2.55	mΩ	(16.7% $\times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)}$), $T_J = T_J$ max.
r_{f2} High level of forward slope resistance	1.11		(I > $\pi \times I_{F(AV)}$), $T_J = T_J$ max.
V_{FM} Max. forward voltage	2.23	V	$I_{pk} = 345A$, $T_J = 25^\circ C$, $t_p = 400 \mu s$ square pulse

Recovery Characteristics

Code	$T_J = 25^\circ C$ typical t_{rr} @ 25% I_{RRM} (μs)	Test conditions			Max. values @ $T_J = 125^\circ C$			
		I_{pk} Square Pulse (A)	di/dt (A/μs)	V_r (V)	t_{rr} @ 25% I_{RRM} (μs)	Q_{rr} (μC)	I_{rr} (A)	
S10	1.0	350	25	-30	1.6	21	27	
S15	1.5				2.3	61	37	
S20	2.0				3.2	75	39	

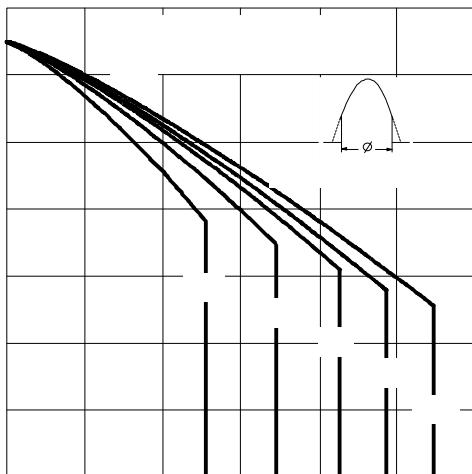


Fig. 1 - Current Ratings Characteristics

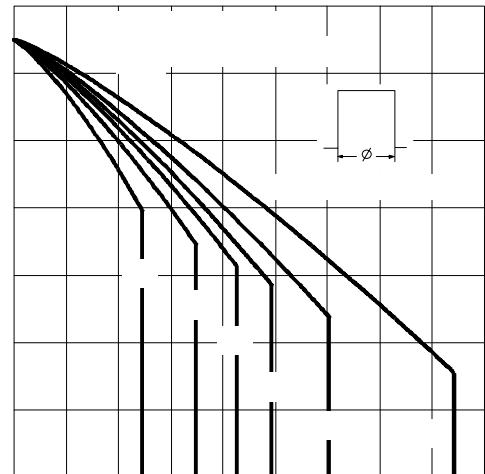


Fig. 2 - Current Ratings Characteristics

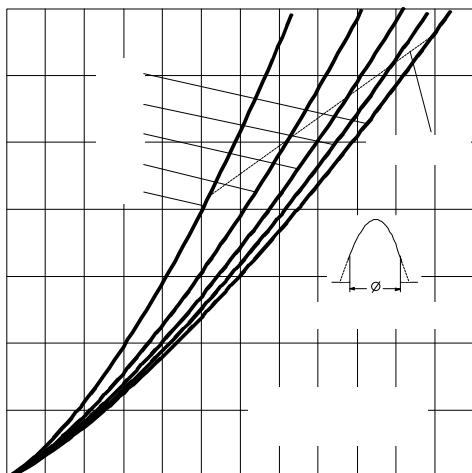


Fig. 3 - Forward Power Loss Characteristics

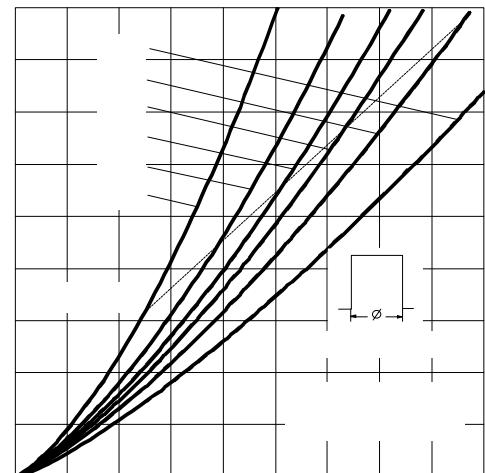


Fig. 4 - Forward Power Loss Characteristics

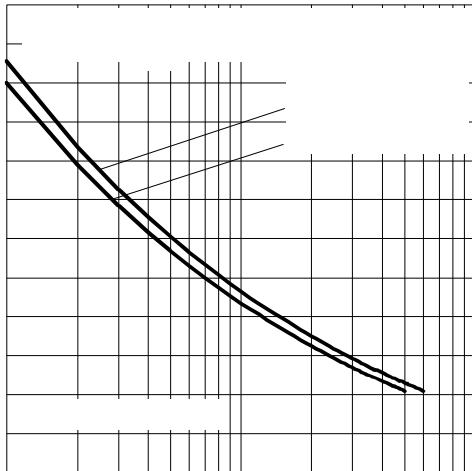


Fig. 5 - Maximum Non-repetitive Surge Current

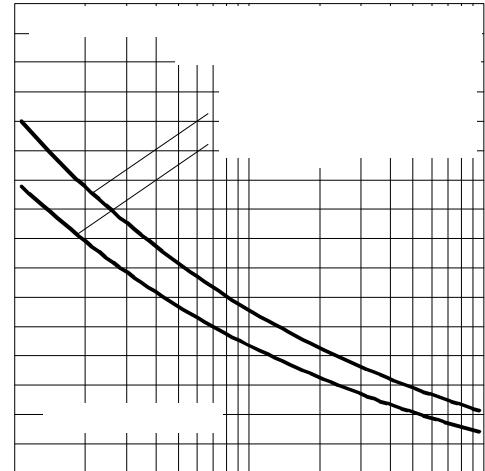


Fig. 6 - Maximum Non-repetitive Surge Current

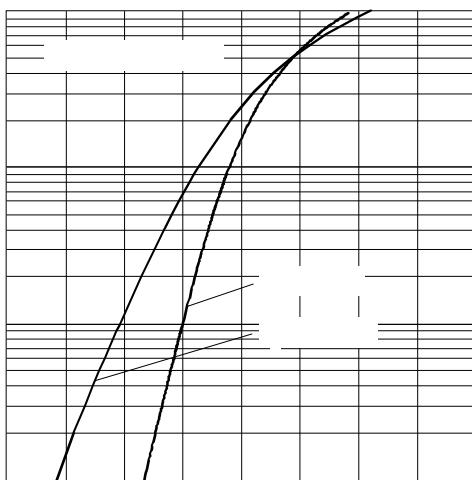


Fig. 7 - Forward Voltage Drop Characteristics

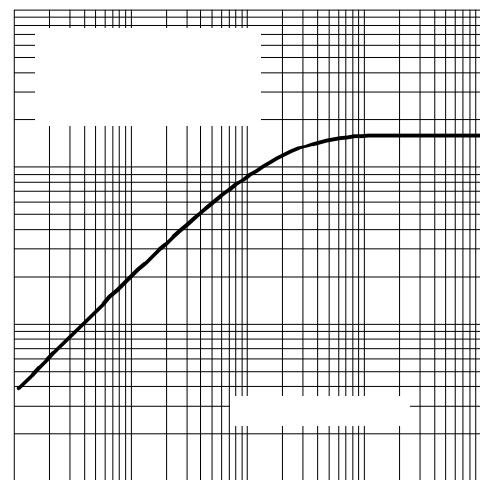
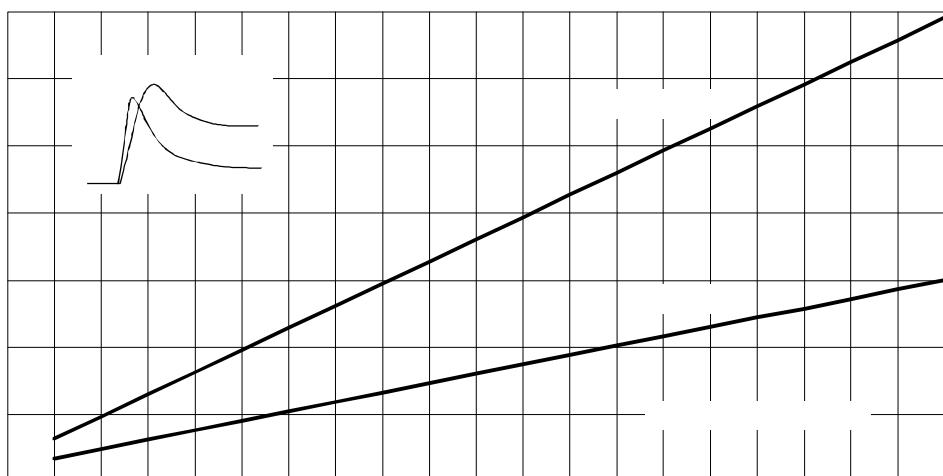
Fig. 8 - Thermal Impedance Z_{thJC} Characteristic

Fig. 9 - Typical Forward Recovery Characteristics

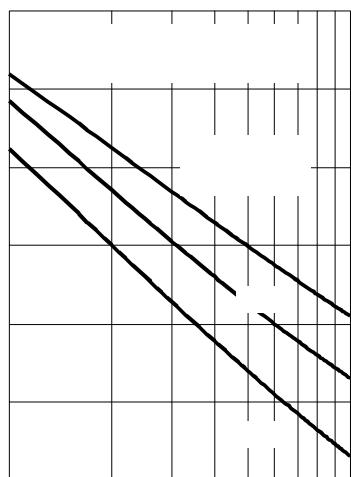


Fig. 10 - Recovery Time Characteristics

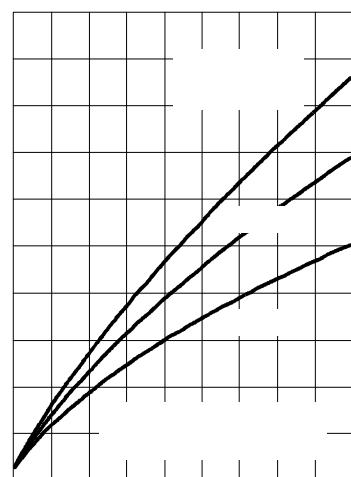


Fig. 11 - Recovery Charge Characteristics

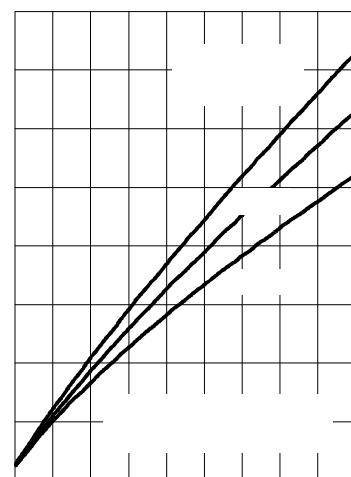


Fig. 12 - Recovery Current Characteristics

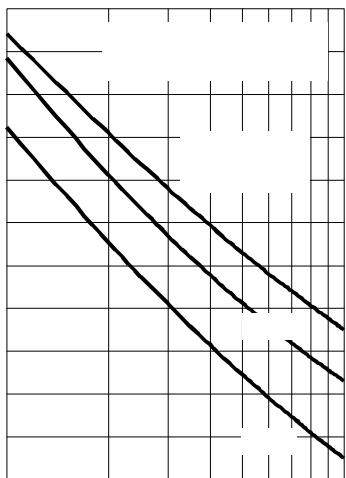


Fig. 13 - Recovery Time Characteristics

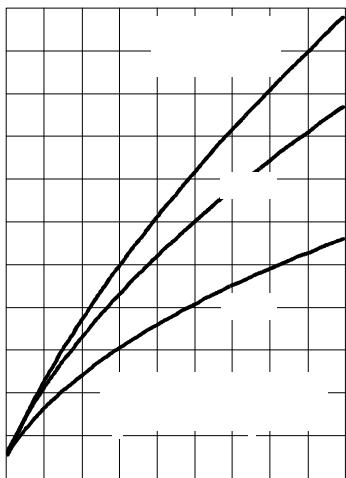


Fig. 14 - Recovery Charge Characteristics

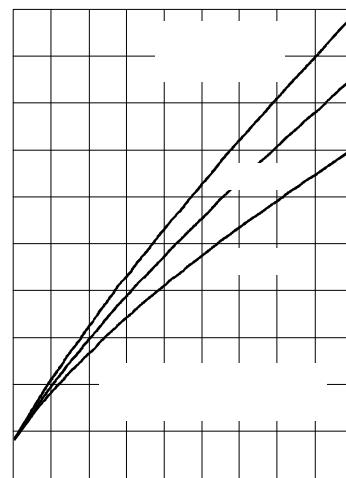


Fig. 15 - Recovery Current Characteristics

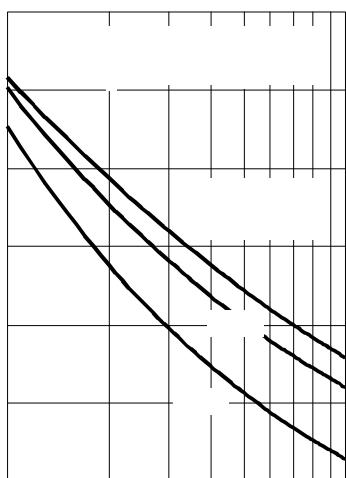


Fig. 16 - Recovery Time Characteristics

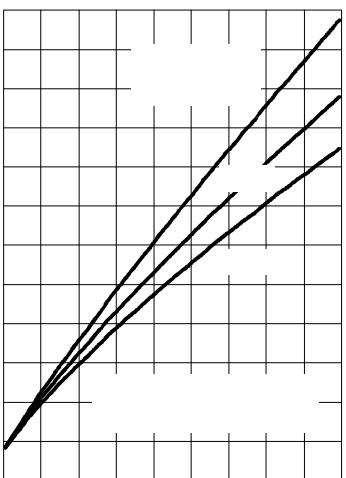


Fig. 17 - Recovery Charge Characteristics

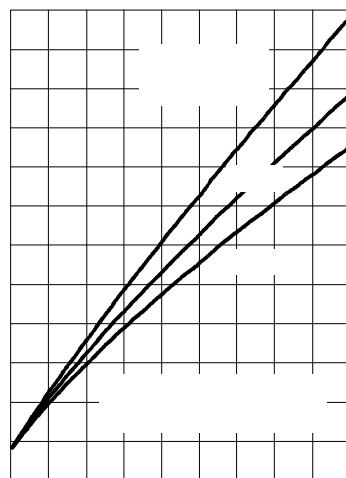


Fig. 18 - Recovery Current Characteristics

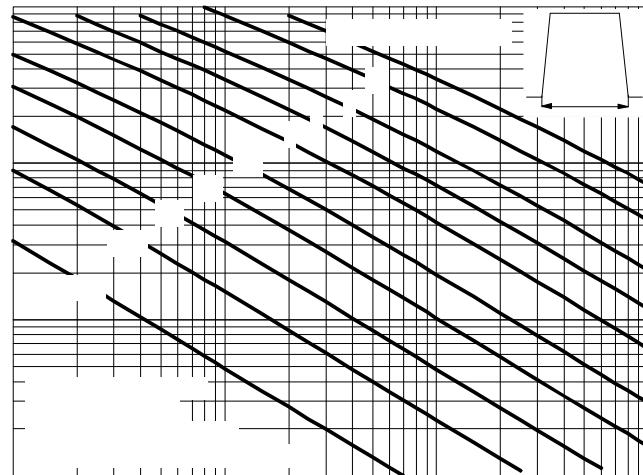
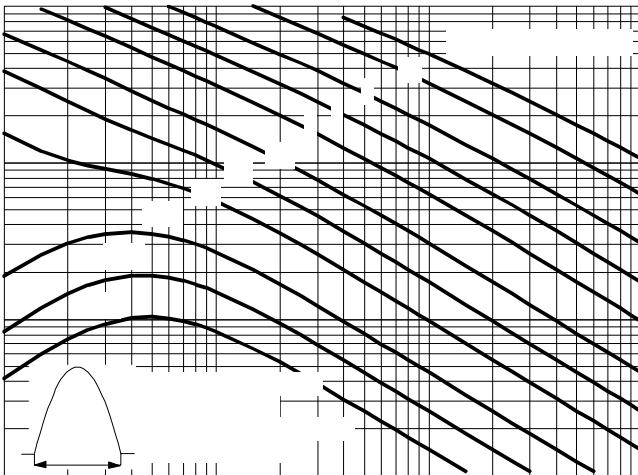


Fig. 19 - Maximum Total Energy Loss Per Pulse Characteristics

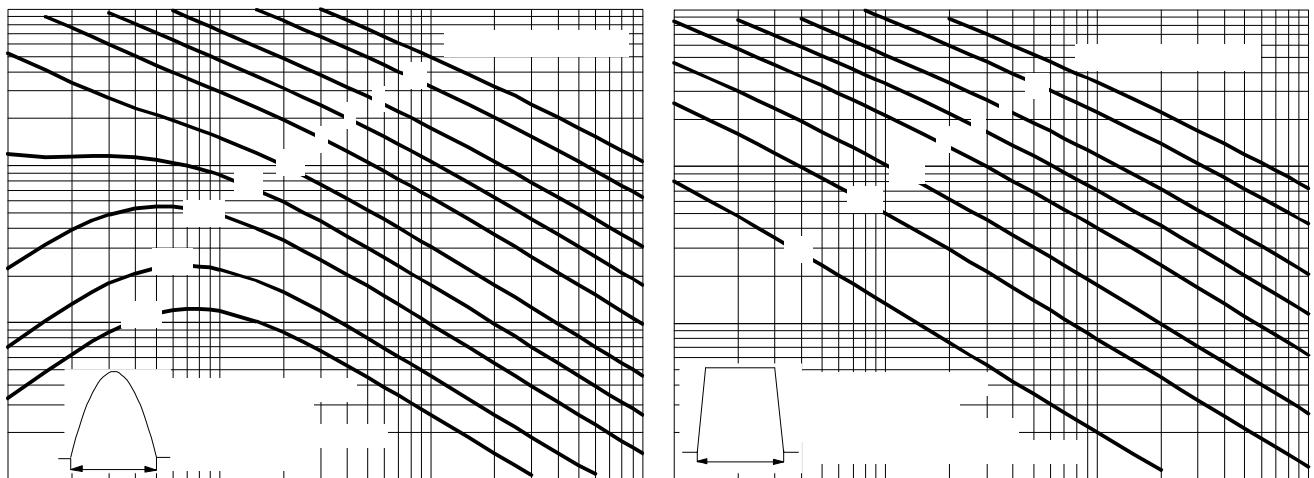


Fig. 20 - Maximum Total Energy Loss Per Pulse Characteristics

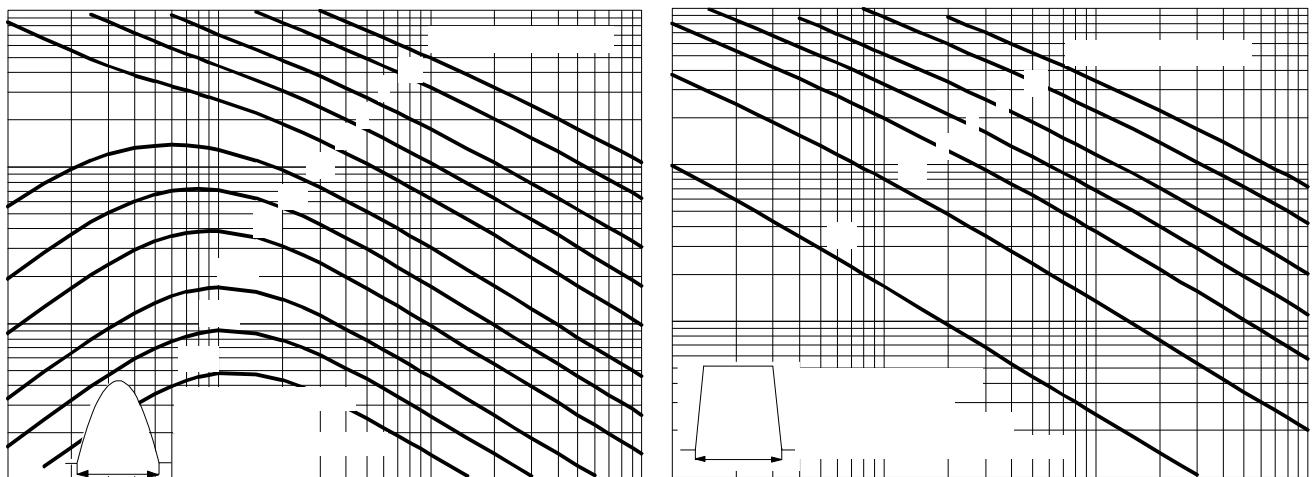


Fig. 21 - Maximum Total Energy Loss Per Pulse Characteristics

Thermal and Mechanical Specification

Parameter	SD103N/R	Units	Conditions
T _J	Max. operating temperature range	-40 to 125	°C
T _{stg}	Max. storage temperature range	-40 to 150	
R _{thJC}	Max. thermal resistance, junction to case	0.16	K/W
R _{thCS}	Max. thermal resistance, case to heatsink	0.10	
T	Mounting torque ± 10%	15.5	Nm
		13.5	
wt	Approximate weight	120	g
Case style		DO-205AC(DO-30)	See Outline Table

$\Delta R_{th,IC}$ Conduction

(The following table shows the increment of thermal resistance $R_{\text{th},C}$ when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.011	0.012	K/W	$T_J = T_{J\max}$
120°	0.016	0.019		
90°	0.021	0.023		
60°	0.029	0.030		
30°	0.041	0.041		

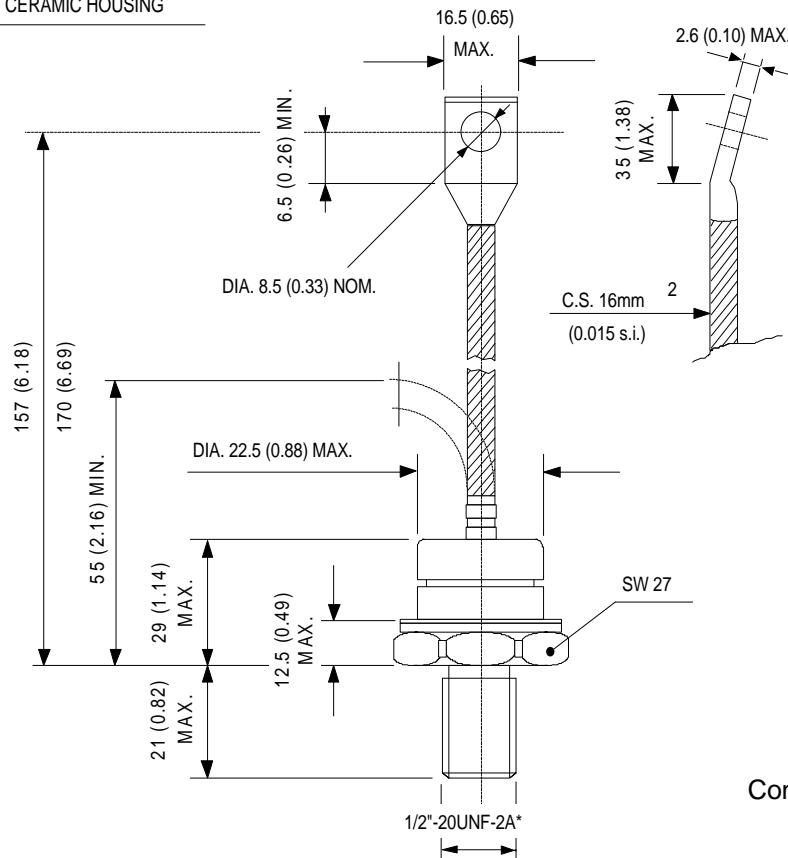
Ordering Information Table

Device Code		SD	10	3	R	25	S20	P	B	C	
		1	2	3	4	5	6	7	8	9	
1	- Diode										
2	- Essential part number										
3	- 3 = Fast recovery										
4	- N = Stud Normal Polarity (Cathode to Stud)										
	R = Stud Reverse Polarity (Anode to Stud)										
5	- Voltage code : Code x 100 = V _{RRM} (see Voltage Ratings table)										
6	- t _{rr} code (see Recovery Characteristics table)										
7	- P = Stud base DO-205AC (DO-30) 1/2" 20UNF-2A										
	M = Stud base DO-205AC (DO-30) M12 X 1.75										
8	- B = Flag top terminals (for Cathode/ Anode Leads)										
	S = Isolated lead with silicone sleeve										
	(Red = Reverse Polarity; Blue = Normal Polarity)										
	None = Not isolated lead										
9	- C = Ceramic housing (over 1600V)										
	V = Glass-metal seal (only up to 1600V)										

SD103N/R Series

Outline Table

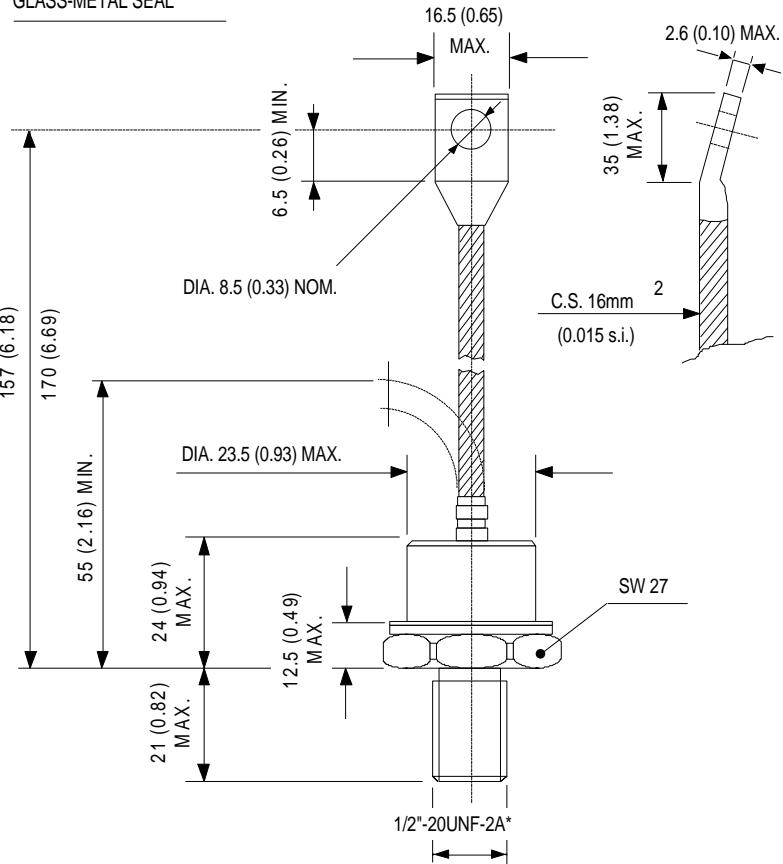
CERAMIC HOUSING



Conforms to JEDEC DO-205AC (DO-30)
All dimensions in millimeters (inches)

* FOR METRIC DEVICE: M12 X 1.75

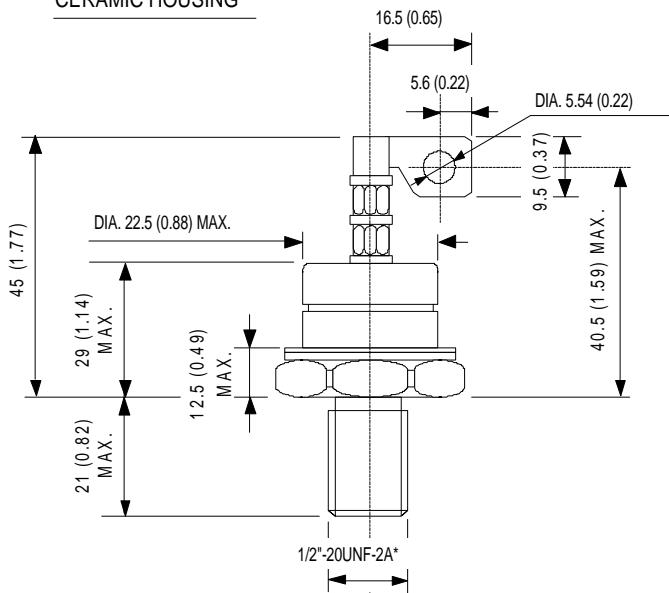
GLASS-METAL SEAL



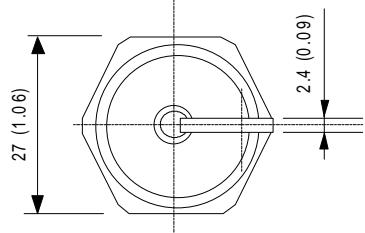
* FOR METRIC DEVICE: M12 X 1.75

Outline Table

CERAMIC HOUSING

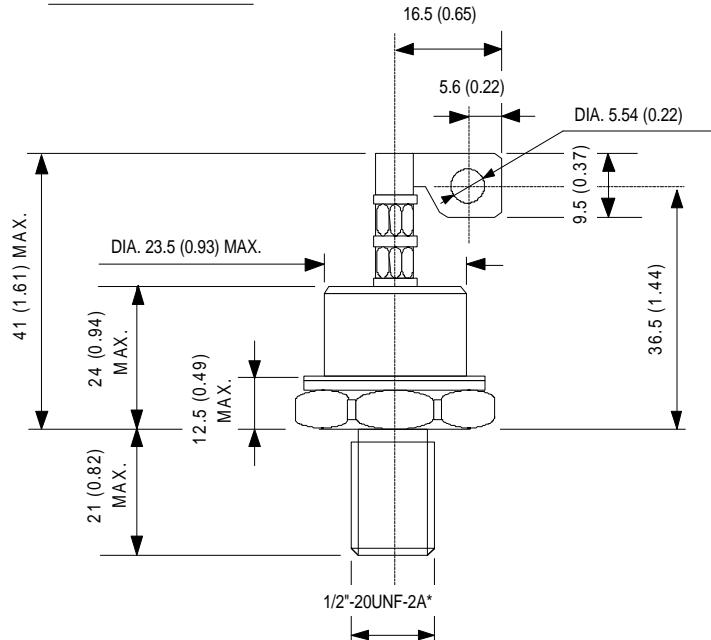


*FOR METRIC DEVICE. M12 X 1.75



DO-205AC (DO-30) Flag
All dimensions in millimeters (inches)

GLASS-METAL SEAL



*FOR METRIC DEVICE. M12 X 1.75

